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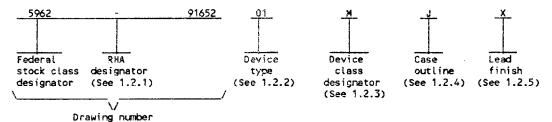
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1. SCOPE

- 1.1 <u>Scope</u>. This drawing forms a part of a one part number documentation system (see 6.6 herein). Two product assurance classes consisting of military high reliability (device classes B, Q, and M) and space application (device classes S and V), and a choice of case outlines and lead finishes are available and are reflected in the Part or Identifying Number (PIN). Device class M microcircuits represent non-JAN class B microcircuits in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices". When available, a choice of radiation hardness assurance (RHA) levels are reflected in the PIN.
 - 1.2 PIN. The PIN shall be as shown in the following example:



- 1.2.1 <u>Radiation hardness assurance (RHA) designator</u>. Device classes M, B, and S RHA marked devices shall meet the MIL-M-38510 specified RHA levels and shall be marked with the appropriate RHA designator. Device classes Q and V RHA marked devices shall meet the MIL-I-38535 specified RHA levels and shall be marked with the appropriate RHA designator. A dash (-) indicates a non-RHA device.
 - 1.2.2 <u>Device type(s)</u>. The device type(s) shall identify the circuit function as follows:

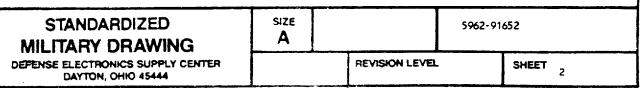
Device type	Generic number	Circuit function
01	TDC1112-1	12-Bit D/A Converter, .048% E _{LD}
02	TDC1112-2	12-Bit D/A Converter, .024% E _{LD}

1.2.3 <u>Device class designator</u>. The device class designator shall be a single letter identifying the product assurance level as follows:

Device class	Device requirements documentation
М	Vendor self-certification to the requirements for non-JAN class B microcircuits in accordance with 1.2.1 of MIL-STD-883
8 or \$	Certification and qualification to MIL-M-38510
Q or V	Certification and qualification to MIL-I-38535

1.2.4 <u>Case outline(s)</u>. For device classes M, B, and S, case outline(s) shall meet the requirements in appendix C of M!L-M-38510 and as listed below. For device classes Q and V, case outline(s) shall meet the requirements of MIL-I-38535, appendix C of M!L-M-38510, and as listed below.

Outline letter	Case outline
J	D-3 (24-lead, 1.290" x .610" x .225") Dual-In-Line
3	C-4 (28-terminal, .460" x .460" x .100"), square chip



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1.2.5 Lead finish. The lead finish shall be as specified in MIL-M-38510 for classes M, B, and S
               or MIL-1-38535 for classes Q and V. Finish letter "Y" shall not be marked on the microcircuit or its
               packaging. The "X" designation is for use in specifications when lead finishes A, B, and C are
               considered acceptable and interchangeable without prevenence.
                                  Absolute maximum ratings 1/
                                  Supply Voltages:
                                      VEEA (measured to Acvo)
VEEA (measured to Acvo)
VEEA (measured to Octo)
VEED (measured to Octo)
                                                                                                                                                                                                        -7.0 V to +0.5 V
                                                                                                                                                                                                       -50 mV to +50 mV
                                                                                                                                                                                                        -7.0 V to +0.5 V
                                                                                                                                                                                                        -0.5 V to +0.5 V
                                  inpugg.
                                      CONV, CONV, FT, D. 12 (measured to D. 2) 2/ -- PEF+, REF-, Spatial Voltage (measured to App) 2/ -- REF+, REF-, raplied current, externally forcad 3/ 4/ Digital input current, externally forcad 3/ 4/ -- --
                                                                                                                                                                                                       YEED to +0.0 V
                                                                                                                                                                                                       ±ŠEAA
                                                                                                                                                                                                        23 mA
                                  Outputs:
                                      CUI+, CUI-, explied voltage (measured to A<sub>CUD</sub>) 2/ - OUI+, CUI-, applied current externally forced, (measured to A<sub>CUD</sub>) 2/ 4/ - - - Short-circuit curation (alique output to GAB) - - -
                                                                                                                                                                                                        -2.0 V to +2.0 V
                                                                                                                                                                                                       Unlimited
                                 Storage temperature range \cdot - \cdot - \cdot - \cdot - \cdot - \cdot - Junction temperature (T_{\cdot}) - \cdot - 
                                                                                                                                                                                                        -60°C to +150°C
                                                                                                                                                                                                       +200°C
                                 Lead temperature (soldering, 10 seconds) - - - - - Power dissipation (P_{\rm p}) - - - - - Thermal resistance, unotion-to-case (\theta_{\rm pp}) - - - - -
                                                                                                                                                                                                       +300°C
                                                                                                                                                                                                        1.6 W
                                                                                                                                                                                                       See MIL-M-38510, appendix C
                1/ Absolute maximum racings are limiting values applied individually while all other parameters are within specified operating conditions. Functional operation under any of these conditions is
                         not implied. Device parisonance and reliability are guaranteed only if the operating conditions
                         are not exceeded.
                       Applied voltage must be current limited to specified range.
                      Forcing voltage must be limited to specified range
              4/ Current is specified as conventional current flowing into the device.
                    1.4 Recommended operating panditions
                                Clock frequency (1000)

Clock frequency (1000)

Analog supply voltage (V<sub>ECA</sub>) (measured to A<sub>GND</sub>) - - -

Analog supply voltage (V<sub>ECA</sub>) (measured to V<sub>ECD</sub>) - - -

Digital supply voltage (V<sub>ECA</sub>) (measured to D<sub>GND</sub>) - - -

Analog ground voltage (V<sub>AGND</sub>) (measured to D<sub>GND</sub>) - - -

Reference voltage range (measured at REF-) - - - -
                                                                                                                                                                                                  0 Hz to 50 MHz
                                                                                                                                                                                                  -4.9 V to -5.5 V
                                                                                                                                                                                                  -20 mV to +20 mV
                                                                                                                                                                                                  -4.9 V to -5.5 V
                                                                                                                                                                                                  -0.1 V to +0.1 V
                                                                                                                                                                                                  -0.7 V to -1.3 V
                                 Reference current range (measured at REF+) - - - - - -
                                                                                                                                                                                                  0.575 mA to 0.675 mA
                                 Compensation capacitor (C<sub>C</sub>) -----
                                                                                                                                                                                                  0.01 #F minimum
                               Compensation capacitor (C<sub>2</sub>)
Digital input voltage, logic LOW (V<sub>11</sub>)
Digital input voltage, logic HIGH (V<sub>1H</sub>)
Input data serup time (t<sub>2</sub>)
Input data hold time (t<sub>3</sub>)
Setup time, data to FT (t<sub>3F</sub>)
Hold time, data to FT (t<sub>1F</sub>)
CONV input voltage, common mode range (V<sub>1CM</sub>)
CONV input voltage, differential (V<sub>1DF</sub>)
                                                                                                                                                                                                  -1.6 V maximum
                                                                                                                                                                                                  -1.0 V minimum
                                                                                                                                                                                                  18 ns minimum
                                                                                                                                                                                                  Ons minimum
                                                                                                                                                                                                  7 ns maximum
                                                                                                                                                                                                 24 ns maximum
                                                                                                                                                                                                  -0.5 V to -2.0 V
                                 CONV input voltage, differential (V<sub>IDF</sub>)
                                                                                                                                                                                                  0.4 V to 1.2 V
                                10.5 ns minimum
                                                                                                                                                                                                  11 ns minimum
                                 CONV pulse width, high (tpwH):
                                           8.5 ns minimum
                                                                                                                                                                                                  9.0 ns minimum
                                 Case operating temperature range (T_p) - - - - - - - -
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2. APPLICABLE DOCUMENTS

2.1 <u>Government specifications, standards, bulletin, and handbook</u>. Unless otherwise specified, the following specifications, standards, bulletin, and handbook of the issue listed in that issue of the Department of Defense Index of Specifications and Standards specified in the solicitation, form a part of this drawing to the extent specified herein.

SPECIFICATIONS

MILITARY

MIL-M-38510

- Microcircuits, General Specification for.

MIL-I-38535

Integrated Circuits, Manufacturing, General Specification for.

STANDARDS

MILITARY

MIL-STD-480 MIL-STD-883

Configuration Control-Engineering Changes, Deviations and Waivers.

- Test Methods and Procedures for Microelectronics.

BULLETIN

MILITARY

MIL-BUL-103

- List of Standardized Military Drawings (SMD's).

HAND8OOK

MILITARY

MIL-HDBK-780

- Standardized Military Drawings.

(Copies of the specifications, standards, bulletin, and handbook required by manufacturers in connection with specific acquisition functions should be obtained from the contracting activity or as directed by the contracting activity.)

2.2 <u>Order of precedence</u>. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence.

3. REQUIREMENTS

- 3.1 Item requirements. The individual item requirements for device class M shall be in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices" and as specified herein. The individual item requirements for device classes B and S shall be in accordance with MIL-M-38510 and as specified herein. For device classes B and S, a full electrical characterization table for each device type shall be included in this SMD. The individual item requirements for device classes Q and V shall be in accordance with MIL-I-38535, the device manufacturer's Quality Management (QM) plan, and as specified herein.
- 3.2 <u>Design, construction, and physical dimensions</u>. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 for device classes M, B, and S and MIL-I-38535 for device classes Q and V and herein.

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DESC FORM 193A SEP 87

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- 3.2.1 Case outline(s). The case outline(s) shall be in accordance with 1.2.4 herein.
- 3.2.2 <u>Terminal connections</u>. The terminal connections shall be as specified on figure 1.
- 3.2.3 Truth table. The truth table shall be as specified on figure 2.
- 3.2.4 Logic diagram. The logic diagram shall be as specified on figure 3.
- 3.2.5 <u>Waveforms and load circuit</u>. The waveforms and load circuit shall be as specified on figure 4.
- 3.3 <u>Electrical performance characteristics and postingualistics and postingualistics</u>. Unless otherwise specified herein, the electrical performance characteristics and postingualistic parameter limits are as specified in table I and shall apply over the full case operating temperature range.
- 3.4 <u>Electrical test requirements</u>. The electrical test requirements shall be the subgroups specified in table IIA. The electrical tests for each subgroup are defined in table I.
- 3.5 Marking. The part shall be marked with the PIM listed in 1.2 herein. Marking for device class M shall be in accordance with MIL-SID-883 (see 3.1 herein). In addition, the manufacturer's PIN may also be marked as listed in MIL-BUL-103. Marking for device classes B and S shall be in accordance with MIL-M-38510. Marking for device classes Q and V shall be in accordance with MIL-I-38535.
- 3.5.1 <u>Certification/compliance mark</u>. The compliance mark for device class M shall be a "C" as required in MIL-STD-883 (see 3.1 herein). The certification mark for device classes 8 and S shall be a "J" or "JAN" as required in MIL-M-38510. The certification mark for device classes Q and V shall be a "QML" as required in MIL-1-38535.
- 3.6 Certificate of compliance. For device class M, a certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-BUL-103 (see 6.7.3 herein). For device classes Q and V, a certificate of compliance shall be required from a QML-38535 listed manufacturer in order to supply to the requirements of this drawing (see 6.7.2 herein). The certificate of compliance submitted to DESC-ECS prior to listing as an approved source of supply for this drawing shall affirm that the manufacturer's product meets, for device class M the requirements of MIL-SID-883 (see 3.1 herein), or for device classes Q and V, the requirements of MIL-I-38535 and the requirements herein.
- 3.7 Certificate of conformance. A certificate of conformance as required for device class M in MIL-STD-383 (see 3.1 herein) or device classes B and S in MIL-H-38510 or for device classes Q and V in MIL-I-38535 shall be provided with each lot of microcircuits delivered to this drawing.
- 3.8 Notification of change for device class M. For device class M. notification to DESC-ECS of change of product (see 6.2 herein) involving devices acquired to this drawing is required for any change as defined in MIL-SID-480.
- 3.9 <u>Verification and review for device class M.</u> For device class M, DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.
- 3.10 <u>Microcircuit group assignment for device classes N. 8. and S.</u> Device classes M. B., and S devices covered by this drawing shall be in microcircuit group number 56 (see MIL-M-38510, appendix E).
- 3.11 <u>Serialization for device class S</u>. All device class S devices shall be serialized in accordance with MIL-M-38510.

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TABLE I. Electrical performance characteristics.

		1		7		-
Test	Symbol	Conditions -55°C ≤ T _C ≤ +125°C unless other#ise specified	Group A subgroups	Lin Min	iits Max	Unit
Supply current	I EEA+	V _{EEA} , V _{EED} = -5.5 V	1,3	- 195		mА
	EED	Jan and y	2	- 145	:	
Reference input <u>2</u> / capacitance	C _{REF}	T _C = +25°C, see 4.4.1 b	4		15	pF
Digital input <u>2</u> /	c ₁	T _C = +25°C, see 4.4.1 b	4		15	
Output capacitance 2/	c _o	Vour+ = +2.0 V, Vour+ = -2.0 V, T _A = +25°C f = 1 MHz, see 4.4.1 b	4		45	
Digital input current, logic LOW	IIL	V _{EED} = -5.5 V V _I = -1.85 V	1,2,3	-10	250	Jua.
Digital input current, logic HIGH	IIH	V _{EED} = -5.5 V V ₁ = -0.8 V	1,2,3	-10	250	
CONV input current	Ic	V _{EED} = -5.5 V -1.85 V ≤ V _I ≤ -0.8 V	1,2,3		50	
Output resistance <u>2</u> /	Ro	V _{OUT+} = +2.0 V, V _{OUT} = -2.0 V	1,2,3	12		ks
Output compliance 2/ voltage	v _{oc}	V _{OUT+} = +2.0 V, V _{OUT-} = -2.0 V	1,2,3	-1.2	1.2	٧
Full-scale output current	I _O	V _{OUT+} = +2.0 V, V _{OUT} = -2.0 V	1,2,3	40		mª
		<u> </u>				

See footnotes at the end of table.

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DESC FORM 193A SEP 87

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TABLE 1. <u>Electrical performance characteristics</u> - Continued.

Test	Symbol	Conditions	Group A	Lim	Unit	
1621	39118001	-55°C ≤ T ≤ ±125°C unless other#ise specified	subgroups	Min	Max	
Maximum clock rate	řs	V _{FFEA} , V _{EED} = -4.9 V, FFEA, 0.8ED see figure 4	4,5,6	50		MSPS
Clock to output delay 2/ 4/	^t DC	V _{FFA} , V _{FFD} = -4.9 V, FFEA, 0.8ED see figure 4	9,10,11		20	ns
Data to output delay 2/ 5/	^t DD	VFEA' 2.5ED = -4.9 V, see figure 4	9,10,11		25	
FT to output delay 2/	t _{DF}	VEEA, VEED = -4.9 V, see fighte 4	9,10,11		30	ļ
Output risetime 2/4/	t _R	90% to 10% of FSR, FT = 0.8 V	9,10,11		4	
Output falltime 2/4/	t _ŗ	10% to 90% of FSR, FT = 0.8 V	9,10,11		4	1
Output voltage settling time 2/	^t SET	FT = 0.8 V, worst case full-scale voltage transition on OUT- to ±.0188% of FS (3/4 LSB) see figure 4	9,10,11		35	
Linearity error, differential <u>6</u> / (device type 01 only)	ELD	VEEA, VEED = -5.2 V, IREF = 0.825 mA	4,5,6	-0.048	+0.048	x
Linearity error, 6/ integral terminal based (device types 01 and 02)	ELI	V _{EEA} , V _{EED} = -5.2 V, I _{REF} = 0.825 mA	4,5,6	-0.048	+0.048	x

See footnotes at the end of table.

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DESC FORM 193A SEP 87

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TABLE I. <u>Electrical performance characteristics</u> - Continued.

Test	Symbol	Conditions	Group A	Lin	Unit	
		-55°C ≤ T _C ≤ +125°C unless otherwise specified	subgroups	Min	Max	
Linearity error, differential <u>6</u> / (device type 02 only)	E _{LD}	V _{EEA} , V _{EED} = -5.2 V, I _{REF} = 0.825 mA	4,5,6	-0.024	+0.024	×
Absolute gain error	E _G	V _{EEA} , V _{EED} V _{REF} = -5.2 V,	1,2,3	-5	+5	x
Output offset current	^I OF	VEEA' VEED = -4.9 V D1-12 = 60.8 V	1,2,3	-5	+5	μΑ
REF+ to REF- offset	v _{os}	V _{EEA} , V _{EED} = -5.5 V	1,2,3	-10	+10	m∨
REF- input bias current 2/	I _B	V _{EEA} , V _{EED} = -5.5 V	1,2,3		10	μΑ
Power supply rejection ratio <u>2</u> /	PSRR	VEEA, VEED = -5.2 V, VEEA and VEED ripple = .6 Vp-p, T = 120 Hz IREF = 0.625 mA, dB relative to 0.6 Vp-p ripple input	4,5,6		-48	d₿
Power supply sensitivity	PSS	V _{EEA} ' V _{EED} = ±4% of -5.2 V I _{REF} = 5.825 mA	4,5,6		-140	μ Α/ V
Peak glitch area 7/2/	G _A		4,5,6		45	pV- sec

 $\frac{1}{2}$ / Worst case over all data and control states. $\frac{2}{2}$ / Guaranteed if not tested to the limits specified. $\frac{3}{3}$ / F_S is limited only by t_{PWL} , t_{PWH} , t_S , and t_H requirements. $\frac{4}{2}$ / Clocked mode. $\frac{5}{2}$ / Feedthrough mode.

6/ OUT- connected to A_{GND}, OUT+ driving virtual ground. 7/ Worst case 1 LSB transistion

STANDARDIZED MILITARY DRAWING	SIZE A	5962-91652				
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DESC FORM 193A SEP 87

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		· · · · · · · · · · · · · · · · · · ·
Device types	01 and	02
Case outlines	J	3
Terminal number	Terminal	symbol
1 2 3 4 5	D9 D10 D11 D12 (LSB)	VEFA REF+ COMP VEED
6 7 8 9 10 11 12	A GND CUT+ CUT- D GND D5 D5 D4 D3 D2	D7 D8 D9 D10 D11 D12 MC AGND
14	D ₁ (MSB)	OUT+
15 16 17 18	CONV CONV FT VEEA	OUT - NC D NEND
19 20 21 22 23 24 25 26 27 28	REF- REF+ COMP VEED D7 D8	D6 D5 D4 D3 D2 O1 (MSB) NC CONV CONV FT

FIGURE 1. Terminal connections.

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DESC FORM 193A SEP 87

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FIGURE 2 TRUTH TABLE

INFILL CODING TABLE

Input Data () 1—12 MSB LSB	OUT+ (mA)	V _{OUT+} (mV)	OUT-(mA)	V _{OUT} (mV
0000 0000 0000	0.000	0.00	40.000	- 1000.90
0000 0000 0001	0.009	-0.24	39.990	-999.75
0000 0000 0010	0.019	-0.49	39.980	-099.52
•	•	•	•	•
•	•	•	•	•
•	•	•	•	•
0111 1111 1111	19.995	-499.88	20.005	-500.12
1000 0000 0000	20.005	-500.12	19.995	-499.38
•	•	•	•	•
•	•	•	•	•
•	•	•	•	•
1111 1111 1101	39.980	-999.52	0.019	-0.49
1111 1111 1110	39.990	-999.75	0.009	-0.04
1111 1111 1111	40.000	-1000.00	0.000	0.00

MOTE. 1. I $_{REF}$ = 625uA, $_{LOAD}$ =25 Ω

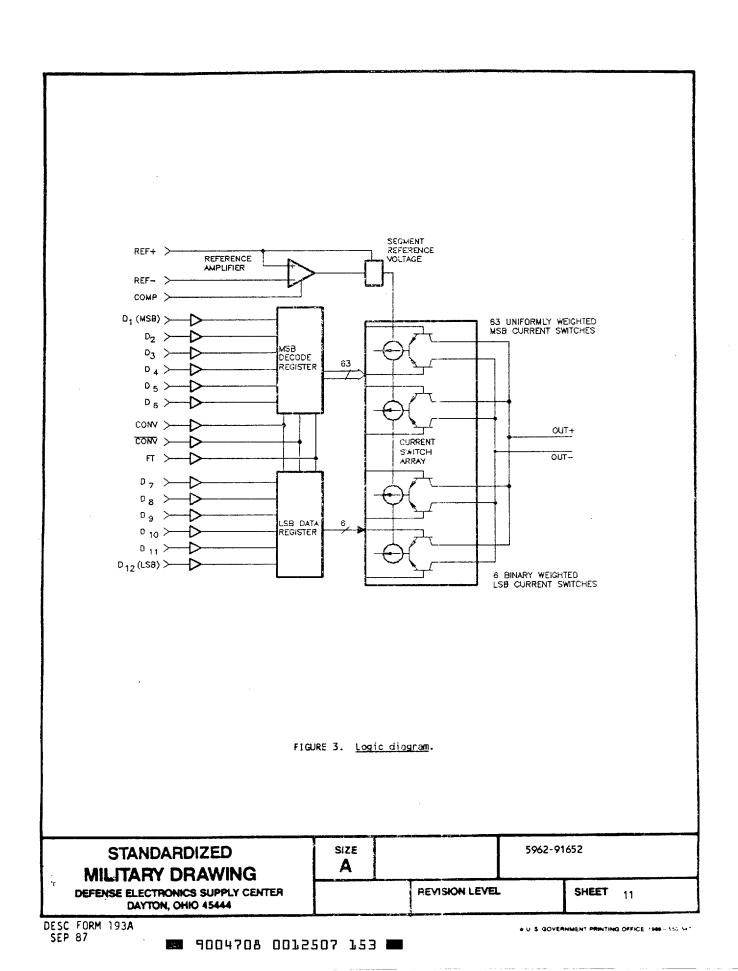
FIGURE 2. <u>Truth table</u>.

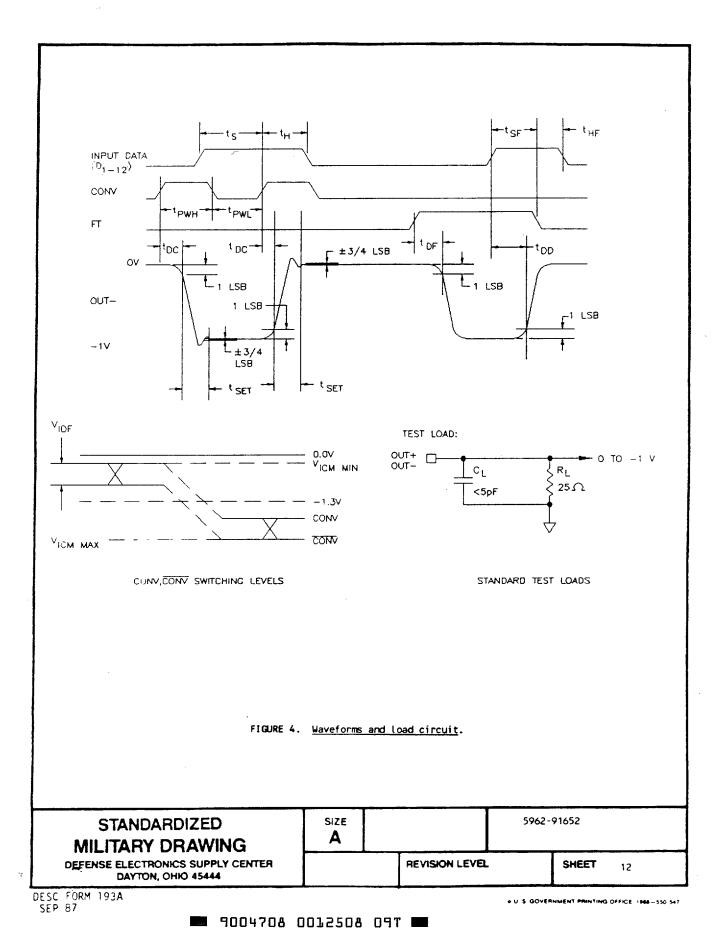
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DESC FORM 193A SEP 87

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4. QUALITY ASSURANCE PROVISIONS

- 4.1 <u>Sampling and inspection</u>. For device class M, sampling and inspection procedures shall be in accordance with section 4 of MIL-M-38510 to the extent specified in MIL-STD-883 (see 3.1 herein). For device classes B and S, sampling and inspection procedures shall be in accordance with MIL-M-38510 and method 5005 of MIL-STD-883, except as modified herein. For device classes Q and V, sampling and inspection procedures shall be in accordance with MIL-I-38535 and the device manufacturer's QM plan.
- 4.2 <u>Screening</u>. For device class M, screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. For device classes 8 and S, screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to qualification and quality conformance inspection. For device classes Q and V, screening shall be in accordance with MIL-1-38535, and shall be conducted on all devices prior to qualification and technology conformance inspection.

4.2.1 Additional criteria for device classes M. B. and S.

- a. Burn-in test, method 1015 of MIL-STD-683.
 - (1) Test condition A, B, C, or D. For device class M, the test circuit shall be submitted to DESC-ECS for review with the certificate of compliance. For device classes B and S, the test circuit shall be submitted to the qualifying activity.
 - (2) $T_A = +125$ °C, minimum.
- b. Interim and final electrical test parameters shall be as specified in table IIA herein.

4.2.2 Additional criteria for device classes Q and V.

- a. The burn-in test duration, test condition and test temperature or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-I-38535. The burn-in test circuit shall be submitted to DESC-ECS with the certificate of compliance and shall be under the control of the device manufacturer's Technology Review Board (TRB) in accordance with MIL-I-38535.
- b. Interim and final electrical test parameters shall be as specified in table IIA herein.
- c. Additional screening for device class 9 beyond the requirements of device class Q shall be as specified in appendix 8 of MIL-I-38535 and as detailed in table IIB herein.

4.3 Qualification inspection.

- 4.3.1 Qualification inspection for device classes 8 and S. Qualification inspection for device classes 8 and S shall be in accordance with MIL-M-38510. Inspections to be performed shall be those specified in method 5005 of MIL-STD-883 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.5).
- 4.3.2 Qualification inspection for device classes Q and V. Qualification inspection for device classes Q and V shall be in accordance with MIL-I-38535. Inspections to be performed shall be those specified in MIL-I-38535 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.5).
- 4.4 <u>Conformance inspection</u>. Quality conformance inspection for device class M shall be in accordance with MIL-STD-883 (see 3.1 herein) and as specified herein. Quality conformance inspection for device classes B and S shall be in accordance with MIL-M-38510 and as specified herein. Inspections to be performed for device classes M, B, and S shall be those specified in method 5005 of MIL-STD-883 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.5). Technology conformance inspection for classes Q and V shall be in accordance with MIL-I-38535 including groups A, B, C, D, and E inspections and as specified herein except where option 2 of MIL-I-38535 permits alternate in-line control testing.

STANDARDIZED MICITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444 SIZE 5962-91652 REVISION LEVEL SHEET 13

DESC FORM 193A SEP 87

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e U.S. GOVERNMENT PRINTING OFFICE 1988-550-547

TABLE IIA. <u>Electrical test requirements</u>.

Test requirements	1	Subgroups nod 5005,ta	Subgroups (per MIL-I-38535, table III)		
	Device class M	Device Device class B \$		Device class Q	Device class V
Interim electrical parameters (see 4.2)	1,2,3	1,2,3	1,2,3	1,2,3	1,2,3
Final electrical parameters (see 4.2)	1/ 2/ 1,2,3, 4,5,6, 9,10,11	1/ 1,2,3, 4,5,6, 9,10,11	1/ 1,2,3, 4,5,6, 9,10,11	1/ 1,2,3, 4,5,6, 9,10,11	1/ 1,2,3, 4,5,6, 9,10,11
Group A test requirements(see 4.4)	1,2,3, <u>2</u> / 4,5,6, 9,10,11	1,2,3, 4,5,6, 9,10,11	1,2,3, 4,5,6, 9,10,11	1,2,3, 4,5,6, 9,10,11	1,2,3, 4,5,6, 9,10,11
Group B end-point electrical parameters (see 4.4)			1,2,3, 4,5,6, 9,10,11		1,2,3, 4,5,6, 9,10,11
Group C end-point electrical parameters (see 4.4)	1,2,3	3/ 1,2,3		1,2,3	
Group D end-point electrical parameters (see 4.4)	1,2,3	1,2,3	1,2,3	1,2,3,	1,2,3
Group E end-point electrical parameters (see 4.4)	1,4	1,4	1,4	1,4	1,4

^{1/} PDA applies to subgroup 1.

4.4.1 Group A inspection.

- Tests shall be as specified in table IIA herein.
- Subgroup 4 ($C_{\rm REF}$, $C_{\rm I}$ and $C_{\rm O}$) shall be measured only for the initial test and after process or design changes which may affect capacitance. b.
- 4.4.2 Group B inspection. The group B inspection end-point electrical parameters shall be as specified in table IIA herein.
- 4.4.3 Group C inspection. The group C inspection end-point electrical parameters shall be as specified in table IIA herein.

STANDARDIZED MILITARY DRAWING	SIZE A	5962-91652			1652	
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444			REVISION LEVEL		SHEET 14	

DESC FORM 193A SEP 87

U S GOVERNMENT PRINTING OFFICE 1888-550-547

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^{2/} Subgroups 9, 10, and 11 are guaranteed if not tested to the limits specified in table I.
3/ Delta limits in accordance with table IIc shall be computed with reference to the previous electrical parameters.

TABLE IIB. Additional screening for device class V.

Test	MIL-STD-883, test method	Lot requirement
Particle impact noise detection	2020	100%
Internal visual	2010, condition A or approved alternate	100%
Nondestructive	2023 or approved alternate	100%
Reverse bias burn-in	1015	100%
Burn-in	1015, total of 240 hours at +125°C	100%
Radiographic	2012	100%

TABLE IIC. Delta limits at +25°C.

Parameters 1/	Device type
	ALL
I EEA TEED	±10 percent of specified value in table I.
E _{LD}	±10 percent of specified value in table I.
ELI	±10 percent of specified value in table I.

^{1/} The above parameters shall be recorded before and after the required burn-in and and life tests to determine the delta.

4.4.3.1 Additional criteria for device classes M. B. and S. Steady-state life test conditions, method 1005 of MIL-STD-883:

- a. Test condition A, B, C, or D. For device class M, the test circuit shall be submitted to DESC-ECS for review with the certificate of compliance. For device classes B and S, the test circuit shall be submitted to the qualifying activity.
- b. $T_A = +125$ °C, minimum.
- c. Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

STANDARDIZED MILTTARY DRAWING	SIZE A	5962-91652				
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444			REVISION LEVEL		SHEET	15

DESC FORM 193A SEP 87

9004708 0012511 684 📟

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- 4.4.3.2 Additional criteria for device classes Q and V. The steady-state life test duration, test condition and test temperature or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-I-38535. The steady-state life test circuit shall be submitted to DESC-ECS with the certificate of compliance and shall be under the control of the device manufacturer's TRB in accordance with MIL-I-38535.
- 4.4.4 <u>Group D inspection</u>. The group D inspection end-point electrical parameters shall be as specified in table IIA herein.
- 4.4.5 <u>Group E inspection</u>. Group E inspection is required only for parts intended to be marked as radiation hardness assured (see 3.5 herein). RHA levels for device classes B, S, Q, and V shall be M, D, R, and H and for device class M shall be M and D. RHA quality conformance inspection sample tests shall be performed at the RHA level specified in the acquisition document.
 - a. RHA tests for device classes B and S for levels M, D, R, and H or for device class M for levels M and D shall be performed through each level to determine at what levels the devices meet the RHA requirements. These RHA tests shall be performed for initial qualification and after design or process changes which may affect the RHA performance of the device.
 - b. End-point electrical parameters shall be as specified in table IIA herein.
 - c. Prior to total dose irradiation, each selected sample shall be assembled in its qualified package. It shall pass the specified group A electrical parameters in table I for subgroups specified in table IIA herein.
 - d. For device classes M, B, and S, the devices shall be subjected to radiation hardness assured tests as specified in MIL-M-38510 for RHA level being tested, and meet the postirradiation end-point electrical parameter limits as defined in table I at T_A = +25°C ±5 percent, after exposure.
 - Prior to and during total dose irradiation testing, the devices shall be biased to
 establish a worst case condition as specified in the radiation exposure circuit.
 - f. For device classes M, B, and S, subgroups 1 and 2 in table V, method 5005 of MIL-STD-883 shall be tested as appropriate for device construction.
 - g. When specified in the purchase order or contract, a copy of the RHA delta limits shall be supplied.

5. PACKAGING

5.1 <u>Packaging requirements</u>. The requirements for packaging shall be in accordance with MIL-M-38510 for device classes M, B, and S and MIL-I-38535 for device classes Q and V.

6. NOTES

- 6.1 <u>Intended use</u>. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.
- 6.1.1 <u>Replaceability</u>. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.
 - 6.1.2 Substitutability. Device classes B and Q devices will replace device class M devices.
- 6.2 <u>Configuration control of SMD's</u>. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished in accordance with MIL-STD-481 using DD Form 1693, Engineering Change Proposal (Short Form).

STANDARDIZED MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444	SIZE A	5962-91652			1652	
			REVISION LEVEL	•	SHEET	16

DESC FORM 193A SEP 87

U & GOVERNMENT PRINTING OFFICE 1988-550,547

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- 6.3 Record of users. Military and industrial users shall inform Defense Electronics Supply Center when a system application requires configuration control and which SMD's are applicable to that system. DESC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronic devices (FSC 5962) should contact DESC-ECS, telephone (513) 296-6022.
- 6.4 <u>Comments</u>. Comments on this drawing should be directed to DESC-ECS, Dayton, Chio 45444, or telephone (513) 296-5375.
 - 6.5 Symbols, definitions, and functional descriptions.
- 6.6 One part one part number system. The one part one part number system described below has been developed to allow for transitions between identical generic devices covered by the four major microcircuit requirements documents (MIL-M-38510, MIL-H-38534, MIL-I-38535, and 1.2.1 of MIL-STD-883) without the necessity for the generation of unique PIN's. The four military requirements documents represent different class levels, and previously when a device manufacturer upgraded military product from one class level to another, the benefits of the upgraded product were unavailable to the Original Equipment Manufacturer (OEM), that was contractually locked into the original unique PIN. By establishing a one part number system covering all four documents, the OEM can acquire to the highest class level available for a given generic device to meet system needs without modifying the original contract parts selection criteria.

Military documentation format	Example PIN under new system	Manufacturing source listing	Document <u>Listing</u>
New MIL-M-38510 Military Detail Specifications (in the SMD format)	5962-XXXXXZZ(B or S)YY	QPL-38510 (Part 1 or 2)	MIL-BUL-103
New MIL-H-38534 Standardized Military Drawings	5962-XXXXXZZ(H or K)YY	QML-38534	MIL-BUL-103
New MIL-I-38535 Standardized Military Drawings	5962-XXXXXZZ(Q or V)YY	QML-38535	MIL-BUL-103
New 1.2.1 of MIL-STD-883 Standardized Military Drawings	5962-XXXXXZZ(M)YY	MIL-BUL-103	MIL-BUL-103

6.7 Sources of supply.

- 6.7.1 <u>Sources of supply for device classes 3 and S</u>. Sources of supply for device classes B and S are listed in QPL-38510.
- 6.7.2 <u>Sources of supply for device classes Q and V</u>. Sources of supply for device classes Q and V are listed in QML-38535. The vendors listed in QML-38535 have submitted a certificate of compliance (see 3.6 herein) to DESC-ECS and have agreed to this drawing.
- 6.7.3 Approved sources of supply for device class M. Approved sources of supply for class M are listed in MIL-BUL-103. The vendors listed in MIL-BUL-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DESC-ECS.

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STANDARDIZED MILITARY DRAWING	SIZE A				552	
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444			REVISION LEVEL	•	SHEET	17

DESC FORM 193A SEP 87

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